



#### **General Description**

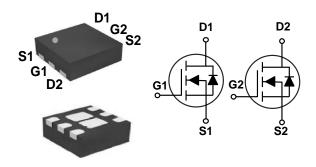
These dual N Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

BV <sub>DSS</sub>	R <sub>DS(ON)</sub>	I <sub>D</sub>
20 V	40 mΩ	5.2 A

#### **Features**

- 20V, 5.2A,  $R_{DS(ON)}$ =40m  $\Omega$  @ $V_{GS}$ =4.5V
- · Green Device Available
- · Fast switching
- · Suit for 1.8V Gate Drive Applications

#### DFN2X2 Dual 2EP Pin Configuration



#### **Applications**

- Notebook
- · Load Switch
- Networking
- · Hand-held Instruments

#### Absolute Maximum Ratings T<sub>C</sub>=25°C unless otherwise noted **Symbol Parameter** Rating Units $V_{DS}$ Drain-Source Voltage 20 $V_{GS}$ ±10 ٧ Gate-Source Voltage 5.2 Drain Current - Continuous (T<sub>C</sub>=25°C) Α $I_D$ 3.3 Α Drain Current - Continuous (T<sub>C</sub>=100°C) $\mathbf{I}_{\mathrm{DM}}$ Drain Current - Pulsed (NOTE 1) 20.8 Α 1.78 W Power Dissipation (T<sub>C</sub>=25°C) $P_D$ 0.02 W/°C Power Dissipation - Derate above 25°C $T_{J}$ Operating Junction Temperature Range -50 to 150 ٥С -50 to 150 Storage Temperature Range $T_{STG}$ ٥С

Thermal Characteristics						
Symbol	Parameter	Тур.	Max	Unit		
$R_{\theta JA}$	Thermal Resistance Junction to Ambient		100	°C/W		





### Electrical Characteristics (T<sub>J</sub>=25°C, unless otherwise noted)

#### **Off Characteristics**

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$V_{GS}$ =0V , $I_D$ =250uA	20			V
1	Drain-Source Leakage Current	$V_{DS}$ =20V , $V_{GS}$ =0V , $T_J$ =25°C			1	uA
IDSS	Diain-Source Leakage Guirent	$V_{DS}$ =16V , $V_{GS}$ =0V , $T_{J}$ =125 $^{\circ}$ C			10	uA
I <sub>GSS</sub>	Gate-Source Leakage Current	$V_{GS}$ =±10V , $V_{DS}$ =0V			±100	nA

#### On Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
R <sub>DS(ON)</sub>	Static Drain-Source On-Resistance	$V_{GS}$ =4.5V , $I_D$ =3A		30	40	mΩ
		$V_{GS}$ =2.5V , $I_D$ =2A		42	55	
		V <sub>GS</sub> =1.8V , I <sub>D</sub> =1.5A		55	80	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{GS}=V_{DS}$ , $I_D=250uA$	0.3	0.6	1.0	V
gfs	Forward Transconductance	$V_{DS}$ =10V , $I_{D}$ =2A		4.4		S

#### **Dynamic and switching Characteristics**

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
$Q_g$	Total Gate Charge (NOTE 2 · 3)			5.8	10	
$Q_{gs}$	Gate-Source Charge (NOTE 2 \cdot 3)	$V_{DS}$ =10V , $V_{GS}$ =4.5V , $I_{D}$ =3A		0.6	1.5	nC
$Q_{gd}$	Gate-Drain Charge (NOTE 2 \cdot 3)			1.5	3	
$T_{d(on)}$	Turn-On Delay Time (NOTE 2 \ 3)			2.9	6	
T <sub>r</sub>	Rise Time (NOTE 2 \cdot 3)	$V_{DD}$ =10V , $V_{GS}$ =4.5V , $R_{G}$ =25 $\Omega$		8.4	16	ns
$T_{d(off)}$	Turn-Off Delay Time (NOTE 2 \ 3)	, I <sub>D</sub> =1A		19.2	38	115
T <sub>f</sub>	Fall Time (NOTE 2 · 3)			5.6	12	
C <sub>iss</sub>	Input Capacitance			315	600	
C <sub>oss</sub>	Output Capacitance	$V_{DS}$ =15V , $V_{GS}$ =0V , F=1MHz		50	80	pF
$C_{rss}$	Reverse Transfer Capacitance	]		40	60	

#### **Drain-Source Diode Characteristics and Ratings**

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Is	Continuous Source Current	V <sub>G</sub> =V <sub>D</sub> =0V, Force Current			3.8	Α
I <sub>SM</sub>	Pulsed Source Current	V <sub>G</sub> -V <sub>D</sub> -OV , 1 Orec current			7.6	Α
$V_{SD}$	Diode Forward Voltage	$V_{GS}$ =0V , $I_{S}$ =1A , $T_{J}$ =25 $^{\circ}$ C			1	V

### NOTES:

- 1. Repetitive Rating: Pulsed width limited by maximum junction temperature.
- 2. The data tested by pulsed , pulse width  $\leq$  300us , duty cycle  $\leq$  2%.
- 3. Essentially independent of operating temperature.





#### **Characteristics Curves**

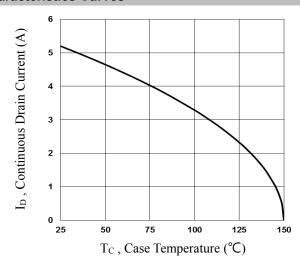


Fig.1 Continuous Drain Current vs. Tc

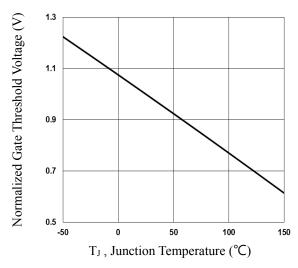


Fig.3 Normalized V<sub>th</sub> vs. T<sub>J</sub>

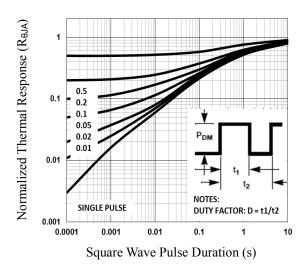


Fig.5 Normalized Transient Impedance

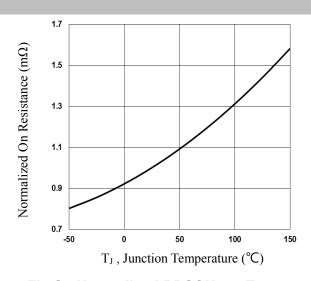


Fig.2 Normalized RDSON vs. TJ

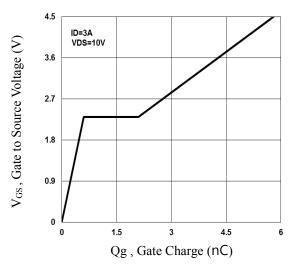
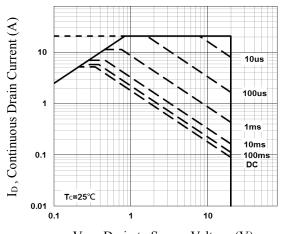


Fig.4 Gate Charge Waveform



 $V_{DS}\,,$  Drain to Source Voltage (V)

Fig.6 Maximum Safe Operation Area





#### **Characteristics Curves**

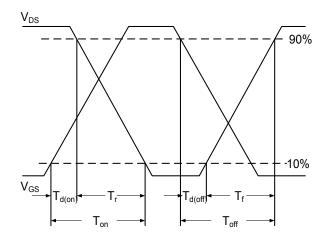


Fig.7 Switching Time Waveform

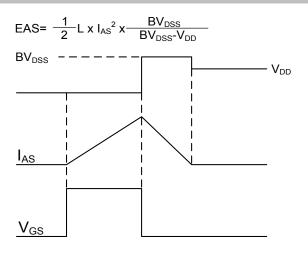
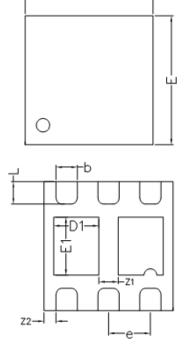


Fig.8 EAS Waveform

### **Package Outline Dimensions**



NOTE: ALL DIMENSIONS IN MM

	MIN	NOM	MAX
D	1.95	2.00	2.05
Е	1.95	2.00	2.05
D1	0.65	0.70	0.75
E1	0.85	0.90	0.95
L	0.30	0.35	0.40
b	0.28	0.33	0.38
е		0.650BSC	
Α	0.45	0.50	0.55
A1		0.15REF	
A2	0.00	_	0.05
Z1	0.25	0.30	0.35
Z2	0.135	0.185	0.235

**DFN2X2 Dual 2EP** 





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